



Wideband Doherty Power Amplifier Design for Base Station Application

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By

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Abstract

Doherty Power Amplifier (DPA) is employed to improve the efficiency when operated with complex modulated signals. Due to its simplicity and high efficiency performance, it has become the preferred choice of industry. However, practical implementations of DPA only provide limited RF bandwidth, especially at high power level. The traditional narrow band device matching network, required phase shift for proper load modulation and impedance inverter seriously limit the bandwidth of DPA.

In this work, the frequency behavior of the ideal 2-way symmetrical DPA is analyzed in detail, followed by the introduction of two new impedance inverters used to improve the bandwidth of DPA. In order to fully exploit the wideband potential of the new impedance inverters, the phase relation between the main and peak amplifier should be adjusted according to the power level at every frequency, which can be stored in a lookup table. Based on a previous wideband 20W DPA with mixed-signal input drive, in which the device output capacitance is incorporated into the impedance inverter, a modified DPA using the idea of compensated impedance inverter is designed and simulated. The prototype DPA design is implemented with NXP LDMOS bare die device. Simulation results have shown more than 50% 6dB back off efficiency from 1.5GHz to 2.2GHz, compared with the original case whose 50% efficiency bandwidth is from 1.9GHz to 2.3GHz.

Since the prototype DPA is implemented at a low power level with bare die devices and mixed-signal input drive, it cannot be used for the practical base station applications. Traditional high power discrete DPA design method is introduced and the frequency behavior is analyzed. It is found that for the high power DPA, the matching network and the offset line are more important than the impedance inverter for the narrow bandwidth of DPA. A new DPA structure was proposed for wideband operation. Simulation results show smaller gain and power added efficiency spread in a 200MHz frequency band from 2.04GHz to 2.24GHz than the traditional DPA.

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Contents

Abstract

Acknowledgments \mathbf{v} 1 Introduction 1 1.1 1 1.2Wireless Transceiver 1 Figures of Merit of Power Amplifier 1.31 1.43 Thesis Structure 1.54 Theory of the Conventional and Doherty Power Amplifier $\mathbf{2}$ $\mathbf{5}$ 2.152.1.152.1.26 2.1.38 Introduction to EER, LINC and DPA 9 2.22.311 2.3.1Load modulation of DPA 11 2.3.2132.3.3Simulation results 152.4Conclusion 15Frequency Behavior of the Ideal Doherty Power Amplifier 173 173.13.2Two New Impedance Inverters 193.2.1Impedance transformation effects of three impedance inverters . . . 193.2.2273.3 DPA with Different Impedance Inverters Bandwidth Comparison 29293.3.1Main and peak amplifier impedance spread with frequency 3.3.2313.3.3 Average efficiency of DPAs with different impedance inverters 33 3.3.43436 3.4Conclusion A Wideband 20W LDMOS Doherty Power Amplifier 37 4 4.1 37 4.1.138 4.1.239 4.1.340DPA performance 404.1.44.2Modified 20W Doherty Power Amplifier 4242142

iii

		4.2.2 Modified compensated quasi-QWTL	44	
		4.2.3 Directly adding compensation line to peak amplifier	45	
		4.2.4 New output network	45	
		4.2.5 Modified 20W DPA performance	47	
	4.3	Layout and Measurement Results	53	
	4.4	Conclusion	53	
5	Hig	h Power Doherty Power Amplifier Bandwidth Discussion	55	
	5.1	High Power Doherty Amplifier Design	55	
		5.1.1 Device characterization	55	
		5.1.2 Matching network	58	
		5.1.3 Offset line	60	
		5.1.4 Doherty power amplifier performance	63	
	5.2	Main Amplifier Frequency Behavior Analysis	65	
		5.2.1 Single TL matched Class-AB with ideal load modulated impedance	65	
		5.2.2 Wideband matched Class-AB with ideal load modulated impedance .	66	
	5.3	The Effect of the Peak Amplifier Offset Line	68	
	5.4	Proposed Bandwidth Improved DPA topology	70	
		5.4.1 DPA output matched to different values	70	
		5.4.2 Proposed wideband DPA topology	71	
	5.5	Conclusion	74	
6	Conclusions and Recommendations			
	6.1	Conclusions	77	
	6.2	Recommendations	78	
		6.2.1 RF power technologies	78	
		6.2.2 Integrated DPA	78	
\mathbf{A}	$\mathbf{DP}_{\mathbf{A}}$	A bandwidth varies with power	81	
в	Cou	pled Line Impedance Transformer	83	
	B.1	Coupled Line	83	
	B.2	Coupled Line with Feedback Transmission Line	84	
	B.3	Alternative Configuration	87	
Bi	bliog	graphy	89	

List of Figures

$1.1 \\ 1.2$	Block diagrams of a generic transmitter and receiver
$2.1 \\ 2.2$	Ideal device transfer characteristic
2.3	Optimum load impedance (a), RF power and efficiency (b) as a function of conduction angle
2.4	Envelop PDFs of differently modulated RF signals
2.5	EER system configuration
2.6	LINC system configuration
2.7	DPA system configuration
2.8	Simplified DPA configuration
2.9	Ideal 2-way symmetrical DPA characteristics
3.1	Efficiency Vs. frequency of DPA at different input drive amplitudes \ldots
3.2	Real and imaginary part of Z_m Vs. normalized frequency $\ldots \ldots \ldots$
3.3	Coupled line impedance inverter
3.4	Compensated impedance inverter
3.5	Impedance transformation effects comparison schematic of 3 different
	impedance inverters(Up to down: QWTL, Coupled line, Compensated
26	impedance inverters)
3.6	effective load impedance $(R_L=0.5\Omega, 1\Omega)$
3.7	Impedance transformation effects comparison schematic of 3 different
0.1	impedance inverters(Up to down: QWTL, Coupled line, Compensated
	impedance inverters)
3.8	Impedance transformation effects of 3 different impedance inverters at back off
	(6dB back off, when $I_m = 0.5$ and $I_p = 0$)
3.9	Impedance transformation effects of 3 different impedance inverters between
	back off and full power (3.1dB back off, when $I_m=0.7$ and $I_p=0.4$)
3.10	Flattest impedance transformation of 3 different impedance inverters between
	back off and full power (3.1dB back off, when $I_m=0.7$ and $I_p=0.4$)
3.11	Flattest impedance transformation of 3 different impedance inverters between
	back off and full power (0.46dB back off, when $I_m=0.9$ and $I_p=0.8$)
3.12	Flattest impedance transformation of 3 different impedance inverters at full
	power $(I_m=1 \text{ and } I_p=1) \dots \dots$
3.13	Performance of compensated impedance inverters with different Z_{sh} compared
	with QWTL impedance inverter
	DPA with LC compensated impedance inverters
3.15	Impedance transformation of LC compensated impedance inverter compared
	with QWTL impedance inverter (Red: QWTL when $R_L=0.5$; Black: QWTL
	when $R_L=1$; Blue: LC compensated inverter when $R_L=0.5$; Magenta: LC
0.1.0	compensated inverter when $R_L=1$)
3.16	QWTL transformation effect

	Compensated impedance inverter transformation effect	29
3.18	Impedance seen by the main amplifier of DPAs with different impedance inverters at different frequencies (from f_0 to $1.4f_0$ with a step of $0.1f_0$)	30
3.19	Impedance seen by the peak amplifier of DPAs with different impedance in-	91
3.20	verters at different frequencies (from f_0 to $1.4f_0$ with a step of $0.1f_0$) Eff and Pout Vs. Freq of DPA with 3 different impedance inverters when drive	31
	voltage=0.5, 1	32
3.21	Eff Vs. Pout @ $1.2f_0$ (Red line: QWTL, Magenta line: Coupled line, Blue line:	
3.22	Compensated)	33
	inverters at different frequencies calculated with this PDF \ldots	33
3.23	Impedance seen by the main and peak amplifier of DPAs with different impedance inverters and optimized phase at different frequencies (from f_0 to	
	$1.4f_0$ with a step of $0.1f_0$)	35
3.24	Efficiency of DPA with two new impedance inverters before(blue line) and after(red line) phase optimization at $1.2f_0 \ldots \ldots \ldots \ldots \ldots \ldots$	36
4.1	Simplified block diagram of the 20W NXP Gen6 wideband DPA	37
4.2	Simplified output network of 10W bare die LDMOS device output $\ldots \ldots$	38
4.3	π -network quasi QWTL	38
4.4	Original QWTL and quasi-QWTL	40
4.5	Drain efficiency versus output power at different frequencies for the original wideband 20W DPA	41
4.6	Drain efficiency of the original 20W DPA at 6dB back off and full power at	
	different frequencies	41
4.7	Compensated quasi-QWTL schematic	42
4.8	Compensated quasi-QWTL	42
4.9	Impedance transformation of original QWTL and quasi-QWTL(Blue line: orig- inal QWTL; Red line with circles: quasi-QWTL; Magenta line: compensated	
	quasi-QWTL)	43
	LDMOS with 28V supply voltage loss mechanism	44
	Shunt short circuited QWTL's impedance	44
	Modified shunt short circuited TL's impedance	45
4.13	Impedance transformation of original QWTL and quasi-QWTL(Blue line: orig- inal QWTL; Red line with circles: quasi-QWTL; Magenta line: modified com-	
	pensated quasi-QWTL)	46
4.14	The schematic of peak device with compensation line	47
4.15	Drain efficiency versus output power at different frequencies (Red line: original	
	DPA; Blue line: DPA with compensation line)	48
4.16	Original output network with compensation line(upper part) and new output	
	network(lower part)	49
	New output network microstrip line structure	49
	New input matching network microstrip line structure	49
4.19	Modified DPA efficiency versus output power compared with original DPA(Red line: modified DPA; Blue line: original DPA)	50

4.20	Drain efficiency versus output power at 6dB back off (a) and full power (b) comparison between original and modified DPA; Peak output power of two DPAs (c)	51
1 91	Main amplifier loading impedances at back off and full power	52
4.22	Layout of the modified DPA	53
5.1	Conventional symmetrical 2-way distributed DPA schematic	55
5.2	DC characteristic of LDMOS BLF7G22LS-130	56
5.3	Load pull simulation result of LDMOS BLF7G22LS-130	57
5.4	The network for which equation (5.1) applies \ldots	58
5.5	Quarter wavelength transformer matching bandwidth comparison for two impedance levels $(2.2\Omega \text{ and } 22\Omega)$	59
5.6	Basics of an inshin output match	60
5.7	Single TL and multi-TLs matching effect at output and input of the device .	61
5.8	Equivalent-load networks at a low-power operation for the DPAs without and with offset line	61
5.9	Main amplifier with offset line power sweep at different load conditions	62
	Peak amplifier off-state impedance rotation by the offset line	63
	Ideal power splitter	64
	DPA performance from 2.11GHz to 2.17GHz	64
	DPA performance compared with Class-AB at 2.14GHz	64
	DPA performance from 1.94GHz to 2.34GHz	65
	Simplified schematic of Class-AB amplifier with offset line, impedance inverter and 25Ω load impedance	65
5.16	Performance of the Class-AB amplifier with offset line and 100Ω load impedance	66
	Comparison between wideband and single TL matched Class-AB	67
	Performance of the wideband Class-AB amplifier with offset line and 100Ω load	0.
0.10	impedance	67
5.19	Performance of the wideband output matched DPA from 2.04GHz to 2.24GHz	
	with a step of 0.05GHz	68
5.20	S parameter looking into the peak amplifier from 2.04GHz to 2.24GHz	69
5.21	Power added efficiency of the DPA with different peak offset line length from	
	2.04GHz to 2.24GHz	69
5.22	Power added efficiency of the DPA matched to different values from 2.04GHz	
	to 2.24GHz	70
5.23	DPA output matched to 25Ω without traditional QWTL impedance inverter .	71
5.24	The performance of the DPA in Figure 5.23 compared with the conventional	
	DPA from 2.04GHz to 2.24GHz (Red lines: 2.04GHz; Blue lines: 2.14GHz;	
	Magenta lines: 2.24GHz)	72
	0.2dB asymmetry rat-race splitter and its performance	73
	The performance of the DPA in Figure 5.23 with rat-race power splitter \ldots	74
5.27	The performance of the wideband input matched DPA in Figure 5.23 with rat	
	race power splitter	74
6.1	From discrete DPA to integrated DPA	79
6.2	Integrated DPA building blocks	. °

A.1	Simplified DPA configuration	81
B.1	Coupled line. The port names are in agreement with directional coupler termi- nology for a backward-wave coupler, while the numeration is the same as that	
		09
	used in filter design with coupled line sections.	00
B.2	Coupled line with feedback transmission line.	84
B.3	Another configuration of coupled line with feedback transmission line	87

List of Tables

2.1	Bias point and conduction angle of different classes	6
3.1	A set of impedance inverter parameters	20
3.2	3 impedance inverters' transformation bandwidth at back off and full power level	21
3.3	Bandwidth of DPA with different impedance inverters	32
3.4	Output power of DPA with different impedance inverters when $V_{drive}=1$	34
3.5	Average efficiency of DPA with different impedance inverters	34
3.6	Optimum phase of the peak amplifier with different impedance inverters for maximum output power when $V_{drive}=1$	34
5.1	Load-pull simulation results summary	57
5.2	Load-pull measurement results summary	58
6.1	Material properties of Si and GaN	78

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